

ONYX® 6" CD / DVD, IC Target, High Rate Magnetics

Metric Specifications

Construction

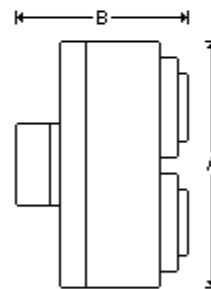
Anode	304 Stainless Steel
Cathode Body	OFHC Copper
Insulator	PTFE / CTFE

Cooling Requirements

Flow Rate at Maximum Power	0.16 LPS
Maximum Input Pressure, Open Drain	4 BAR
Maximum Input Temperature	20 °C

Dimensions

A	Consult Factory
B	Consult Factory



General

Magnetic Enhancement	Permanent (NdFeB) Encapsulated
Maximum Temperature	100 °C
Source to Substrate Distance	25.4 mm - 203.2 mm
Weight, Approximate Without Options	Consult Factory

Maximum Sputtering Power *

Cathode Voltage	100 - 1500 Volts
Discharge Current	20 Amps
Indirect Cooled Mode, DC	10 kW
Indirect Cooled Mode, RF	Consult Factory
Operating Pressure	0.5 - 50 mTorr

Mounting, Standard

Cathode Mounting	Flange
Power Connector, DC	7/16 DIN
Water, Outer Dimension Tubing	12.7 mm

Target

Cooling	Indirect
Diameter	152.4 mm
Form	Circular / Planar
Thickness	Consult Factory

Specifications Disclaimer

- All Angstrom Sciences NdFeB magnets are totally encapsulated and protected from degradation by water.
 - All sources are available in external configurations.
 - * Maximum power for cathode only, a target material's properties, such as, thermal and electrical conductivity may limit the maximum process power level.
 - Some custom-engineered and specialty magnetrons may not meet standard specifications.
 - Specifications are subject to change without notice.
 - Typical performance. Results may vary with process parameters such as pressure, flow rate, target material, and substrate rotation, etc.
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